

MOS FIELD EFFECT TRANSISTOR 2SK3296

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3296 is N-Channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

ORDERING INFORMATION

PART NUMBER		PACKAGE		
2SK3296		TO-220AB		
2SK3296-S		TO-262		
25	K3296-ZK	TO-263(MP-25ZK)		
2SK3296-ZJ		TO-263(MP-25ZJ)		

FEATURES

- 4.5 V drive available
- Low on-state resistance $R_{DS(on)1}$ = 12 m Ω MAX. (Vgs = 10 V, ID = 18 A)

Low gate charge
 Q_G = 30 nC TYP. (I_D = 35 A, V_{DD} = 16 V, V_{GS} = 10 V)

- Built-in gate protection diode
- Surface mount device available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	20	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±35	А
Drain Current (Pulse) Note	D(pulse)	±140	А
Total Power Dissipation (T _A = 25°C)	P _{T1}	1.5	W
Total Power Dissipation (Tc = 25°C)	Pt2	40	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

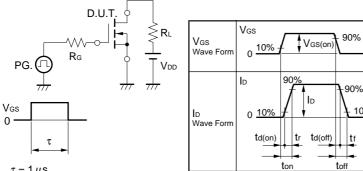
Note $PW \le 10 \ \mu s$, Duty Cycle $\le 1\%$

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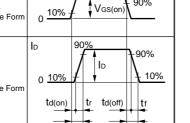
ELECTRICAL CHARACTERISTICS(TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	loss	V _{DS} = 20 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	less	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0		2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 18 A	9.0			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 18 A		8.5	12	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 18 A		12	19	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1300		pF
Output Capacitance	Coss	V _{GS} = 0 V		570		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		300		pF
Turn-on Delay Time	td(on)	V _{DD} = 10 V , I _D = 18 A		70		ns
Rise Time	tr	V _{GS(on)} = 10 V		1220		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		100		ns
Fall Time	tr	_		180		ns
Total Gate Charge	QG	V _{DD} = 16 V		30		nC
Gate to Source Charge	QGS	V _{GS} = 10 V		4.5		nC
Gate to Drain Charge	Qgd	I⊳ = 35 A		8.0		nC
Diode Forward Voltage	VF(S-D)	IF = 35 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 35 A, VGS = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		23		nC

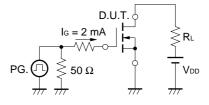
TEST CIRCUIT 1 SWITCHING TIME



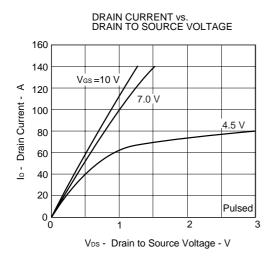
 $\tau = 1 \mu s$ Duty Cycle ≤ 1%

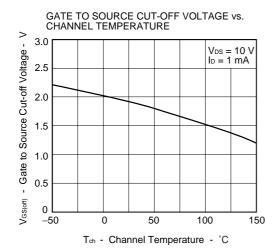


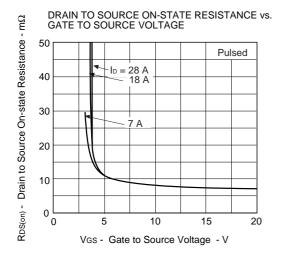
TEST CIRCUIT 2 GATE CHARGE

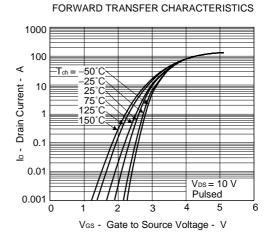


TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

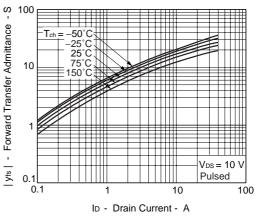


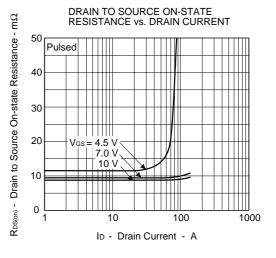




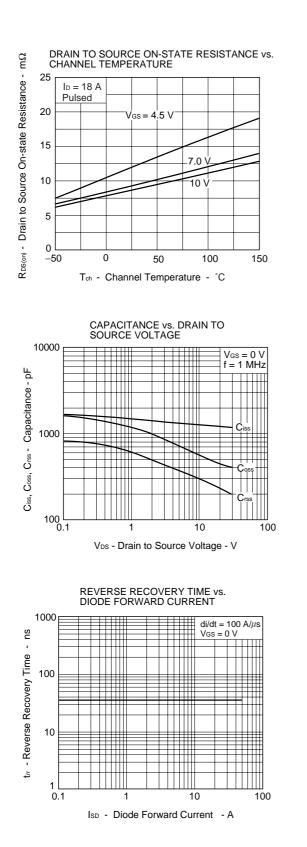


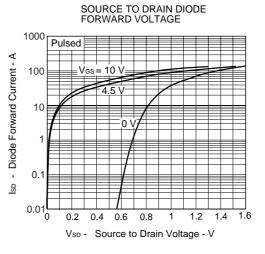
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



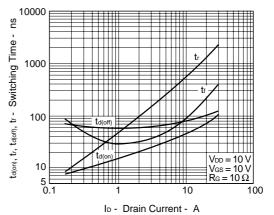


NEC

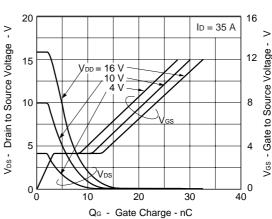




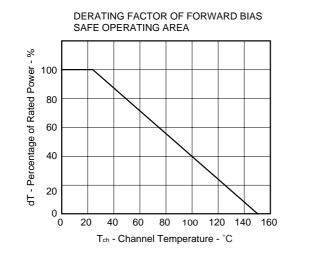
SWITCHING CHARACTERISTICS

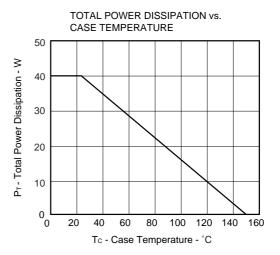




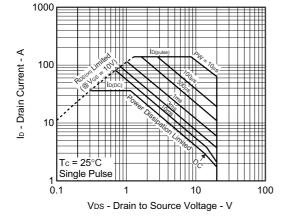


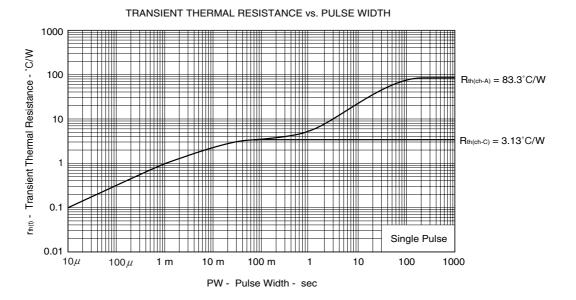






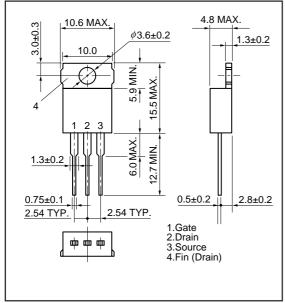




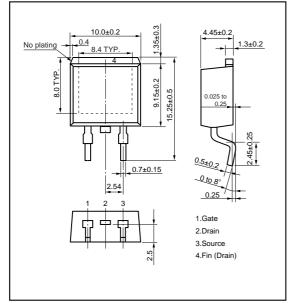


PACKAGE DRAWINGS (Unit : mm)

1)TO-220AB (MP-25)



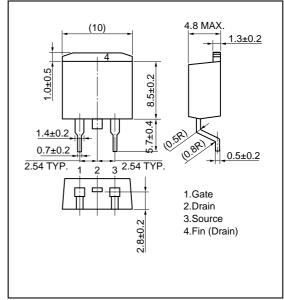
3)TO-263 (MP-25ZK)



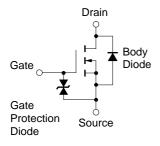
1.0±0.5 4.8 MAX. (10)<u>1.3±0.2</u> F 8.5±0.2 2 3 NIN 1.3±0.2 12.7 2.8±0.2 0.5±0.2 0.75±0.3 2.54 TYP 2.54 TYP. 1.Gate 2.Drain 3.Source 4.Fin (Drain) ф ф ф

4)TO-263 (MP-25ZJ)

2)TO-262



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device. [MEMO]

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